

DMTH6002LPSWQ

60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on) Max	l⊳ Tc = +25°C
60V	2mΩ @ V _{GS} = 10V	190A
	3.3mΩ @ V _{GS} = 4.5V	150A

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

PowerDI5060-8 (SWP) (Standard)

- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

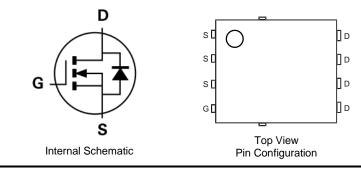
Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Low RDS(ON) Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH6002LPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Top View

Part Number	Case	Packaging
DMTH6002LPSWQ-13	PowerDI5060-8 (SWP) (Standard)	2,500 / Tape & Reel

EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Pin1

Bottom View

Marking Information

Notes:



D ! != Manufacturer's Marking TH6002LSW = Product Type Marking Code YYWW or $\overline{YY}WW$ = Date Code Marking YY or \overline{YY} = Last Two Digits of Year (ex: 20 = 2020) WW = Week Code (01 to 53)

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1 of 7 www.diodes.com



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		Vdss	60	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	Tc = +25°C Tc = +100°C	lo	190 130	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		ldм	760	A
Maximum Continuous Body Diode Forward Current (Note 6)		ls	190	A
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		Ism	760	A
Avalanche Current, L = 3mH		las	21	А
Avalanche Energy, L = 3mH		E _{AS}	662	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	3.13	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	48	°C/W
Total Power Dissipation (Note 6)	$T_{\rm C} = +25^{\circ}{\rm C}$	PD	150	W
Thermal Resistance, Junction to Case (Note 6)		R _{θJC}	1.0	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

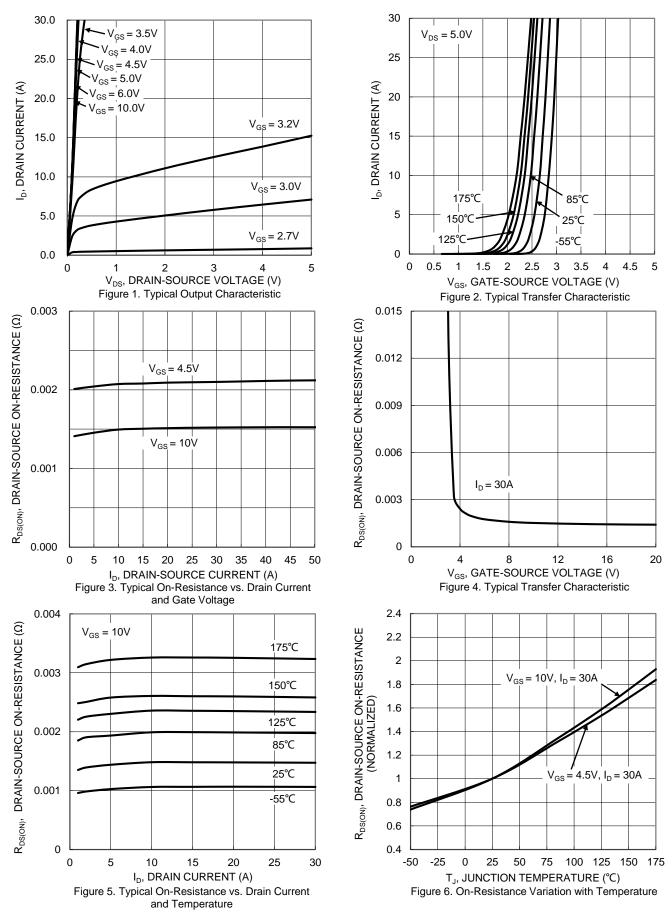
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	60	_		V	$V_{GS} = 0V, I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS		_	1	μA	$V_{DS} = 48V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	1	—	3	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance	D	_	1.5	2	mΩ	$V_{GS} = 10V, I_D = 30A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	2.1	3.3	1112	Vgs = 4.5V, Ip = 30A
Diode Forward Voltage	Vsd	_	0.8	1.2	V	Vgs = 0V, Is = 30A
DYNAMIC CHARACTERISTICS (Note 8)						·
Input Capacitance	Ciss		8289	—		$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz
Output Capacitance	Coss		2467	—	pF	
Reverse Transfer Capacitance	Crss		179	_		
Gate Resistance	Rg		0.76	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge ($V_{GS} = 4.5V$)	Qg	_	68	_		Vds = 30V, Id = 50A
Total Gate Charge (V _{GS} = 10V)	Qg	_	131	_	nC	
Gate-Source Charge	Qgs	_	20.3	_	nc	
Gate-Drain Charge	Qgd	_	30.5	_		
Turn-On Delay Time	tD(ON)	_	9.8	_		
Turn-On Rise Time	t _R	_	17.1	_	ns	V _{DD} = 30V, V _{GS} = 10V,
Turn-Off Delay Time	tD(OFF)		67.3	_		$I_{D} = 50A, R_{g} = 2.5\Omega$
Turn-Off Fall Time	tF		32.9	_		-
Body Diode Reverse Recovery Time	t _{RR}		67	_	ns	
Body Diode Reverse Recovery Charge	Qrr	_	141	_	nC	$I_F = 50A$, di/dt = 100A/µs

 Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad).
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:

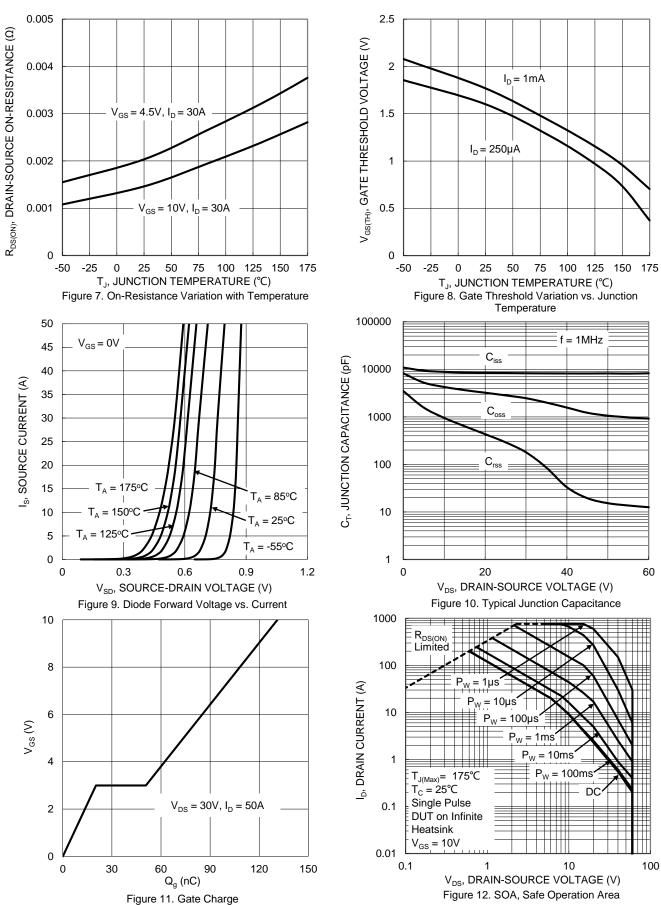


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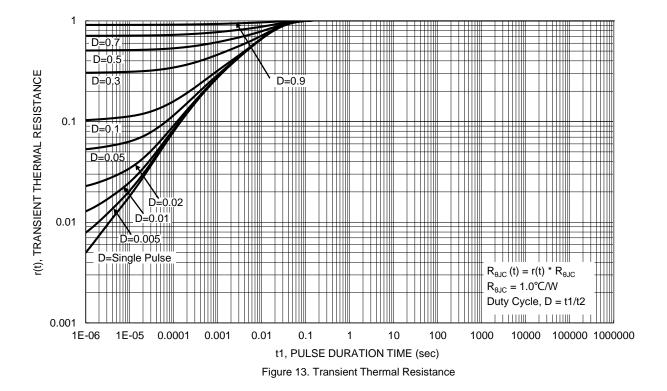


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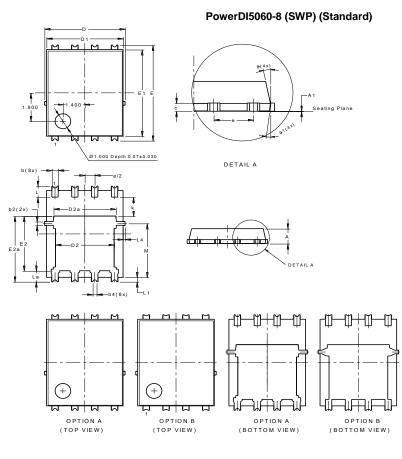






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

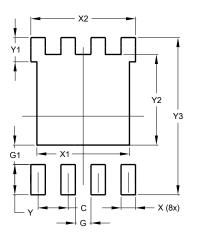


Pov	PowerDI5060-8 (SWP)					
	(Standard)					
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	().25REF	-			
С	0.230	0.330	0.277			
D	5	5.15 BS0	2			
D1	4.70	5.10	4.90			
D2	3.56	3.96	3.76			
D2a	3.78	4.18	3.98			
E	6	6.40 BSC	2			
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е	1	1.27BSC)			
k	1.05					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L4	0.025	0.225	0.125			
Μ	3.205	4.005	3.605			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Standard)



Dimensions	Value (in mm)		
C	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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